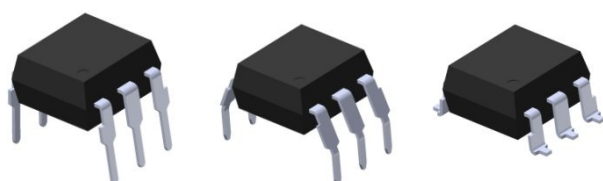
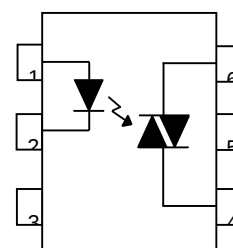


6 PIN DIP RANDOM-PHASE TRIAC DRIVER PHOTOCOUPLER EL301X, EL302X, EL305X Series



Schematic



Pin Configuration

1. Anode
2. Cathode
3. No Connection
4. Terminal
5. Substrate
(do not connect)
6. Terminal

Features:

- Peak breakdown voltage
 - 250V: EL301X
 - 400V: EL302X
 - 600V: EL305X
- High isolation voltage between input and output (Viso=5000 V rms)
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Description

The EL301X, EL302X and EL305X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon random phase photo Triac.

They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115 to 240 VAC operations.

Applications

- Solenoid/valve controls
- Lamp ballasts
- Static AC power switch
- Interfacing microprocessors to 115 to 240Vac peripherals
- Incandescent lamp dimmers
- Temperature controls
- Motor controls

Absolute Maximum Ratings (Ta=25 °C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	60	mA
	Reverse voltage	V_R	6	V
	Power dissipation	P_D	100	mW
	Derating factor (above $T_a = 85^\circ\text{C}$)		3.8	mW / $^\circ\text{C}$
Output	EL301X	V_{DRM}	250	V
	Off-state Output Terminal Voltage		400	
	EL302X		600	
	EL305X	I_{TSM}	1	A
	Peak Repetitive Surge Current (pw=100μs,120pps)		100	
	On-State RMS Current		300	
	Power dissipation		7.4	mW/
	Derating factor (above $T_a = 85^\circ\text{C}$)	P_C		
Total power dissipation		P_{TOT}	330	mW
Isolation voltage ^{*1}		V_{ISO}	5000	Vrms
Operating temperature		T_{OPR}	-55 to 100	
Storage temperature		T_{STG}	-55 to 125	
Soldering Temperature ^{*2}		T_{SOL}	260	

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2&3 are shorted together, and pins 4, 5 & 6 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25 unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward Voltage	V_F	-	1.18	1.5	V	$I_F = 10\text{mA}$
Reverse Leakage current	I_R	-	-	10	μA	$V_R = 6\text{V}$

Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Peak Blocking Current	I_{DRM}	-	-	100	nA	$V_{\text{DRM}} = \text{Rated } V_{\text{DRM}}$ $I_F = 0\text{mA}$
Peak On-state Voltage	V_{TM}	-	-	2.5	V	$I_{\text{TM}} = 100\text{mA peak}$, $I_F = \text{Rated } I_{\text{FT}}$
Critical Rate of Rise off-state Voltage	EL301X EL302X EL305X dv/dt	- 1000	100 -	- -	$\text{V}/\mu\text{s}$	$V_{\text{PEAK}} = \text{Rated } V_{\text{DRM}}$, $I_F = 0$ (Fig. 8) $V_{\text{PEAK}} = 400\text{V}$, $I_F = 0$ (Fig. 8)

Transfer Characteristics

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
LED Trigger Current	EL3020			30		
	EL3010					
	EL3021	-	-	15		
	EL3051					
	EL3011					
	EL3022	-	-	10		
	EL3052					
	EL3012	-	-	5		
	EL3023					
	EL3053					
Holding Current	I_H	-	250	-	μA	Main terminal Voltage=3V

* Typical values at $T_a = 25^\circ\text{C}$

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

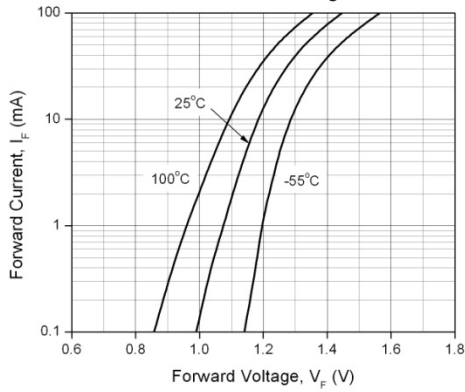


Figure 2. On-State Characteristics

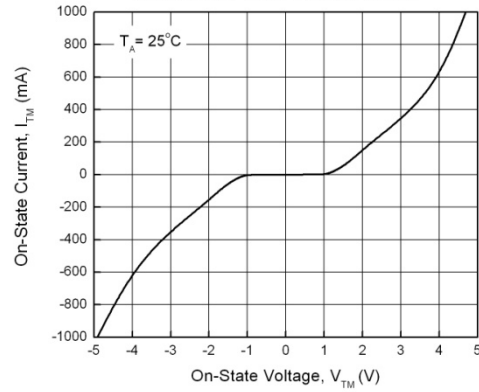


Figure 3. Holding Current vs. Ambient Temperature

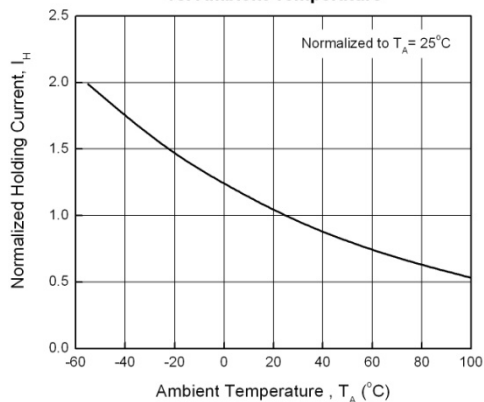


Figure 4. LED Current Required to Trigger vs. LED Pulse Width

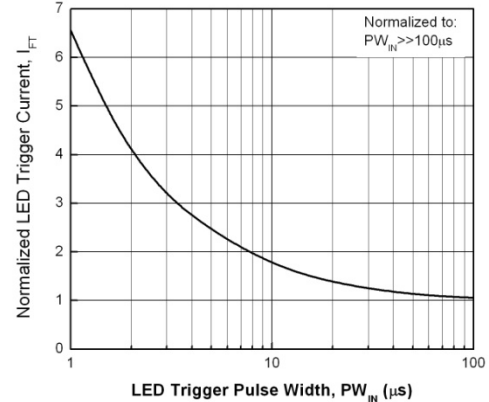


Figure 5. Leakage Current vs. Ambient Temperature

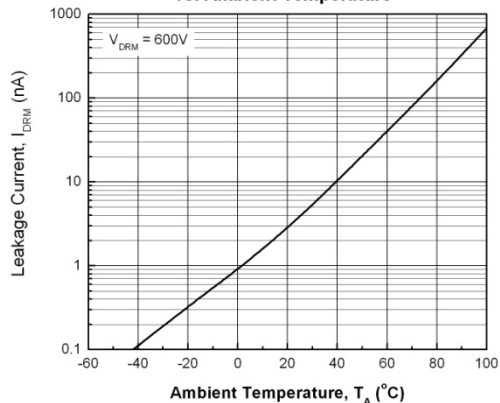
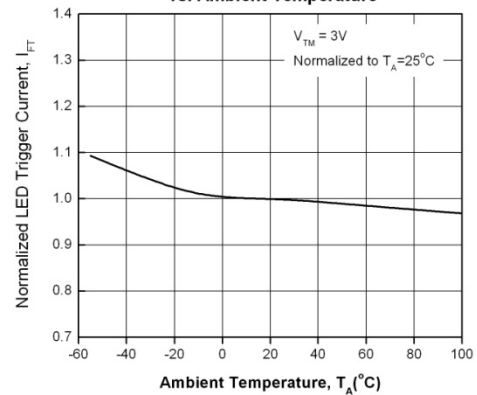


Figure 6. LED Trigger Current vs. Ambient Temperature



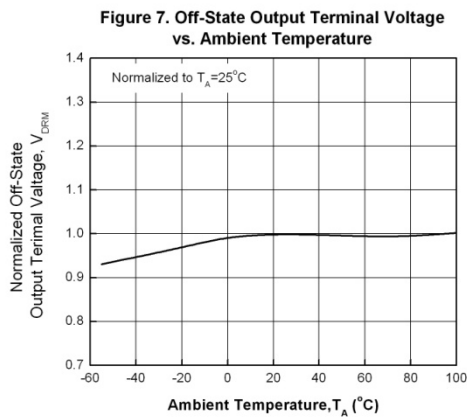
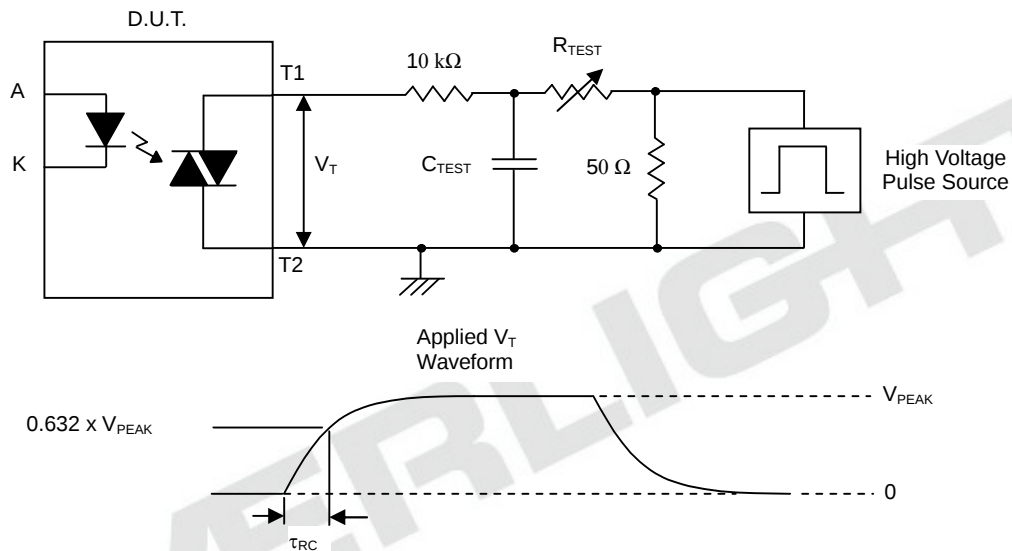


Figure 8. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$\text{dv/dt} = \frac{0.632 \times V_{\text{PEAK}}}{\tau_{\text{RC}}}$$

For example, $V_{\text{PEAK}} = 400\text{V}$ for EL302X series. The dv/dt value is calculated as follows:

$$\text{dv/dt} = \frac{0.63 \times 400}{\tau_{\text{RC}}} = \frac{252}{\tau_{\text{RC}}}$$

Order Information

Part Number

EL301XY(Z)-V
or **EL302XY(Z)-V**
or **EL305XY(Z)-V**

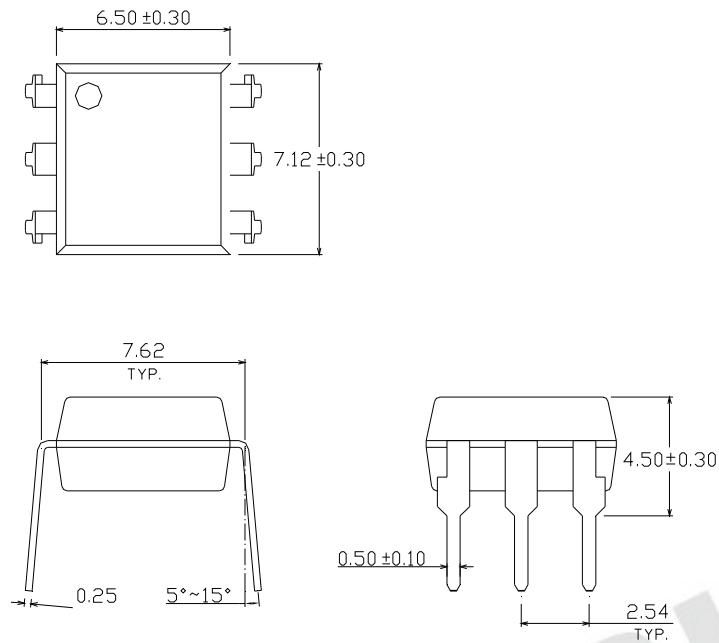
Note

X = Part No. for EL301x (0, 1 or 2)
X = Part No. for EL302x, EL305x (1, 2 or 3)
Y = Lead form option (S, S1, M or none)
Z = Tape and reel option (TA, TB or none).
V = VDE safety approved (optional)

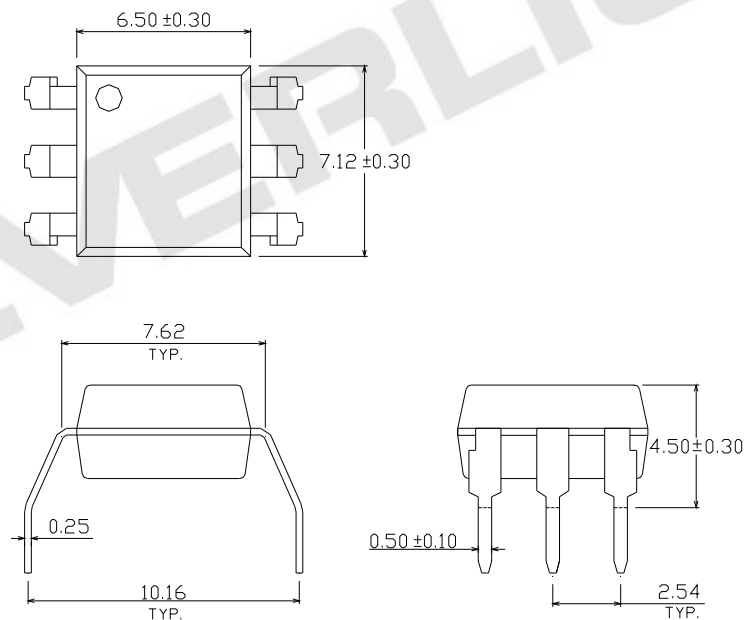
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
M	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

Package Dimension (Dimensions in mm)

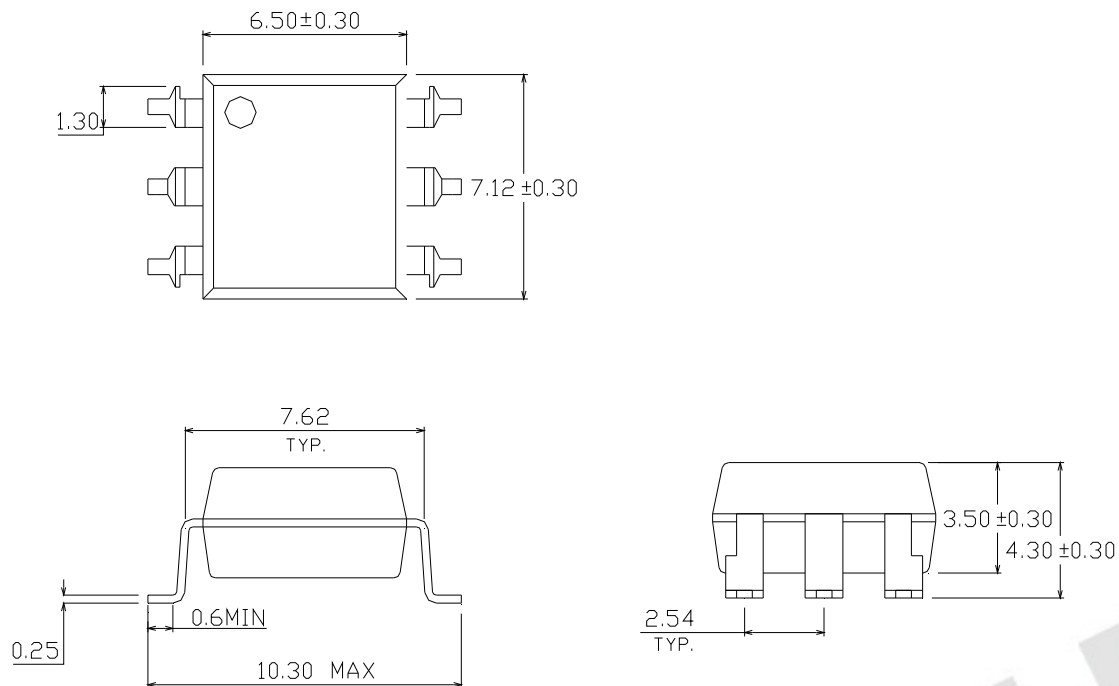
Standard DIP Type



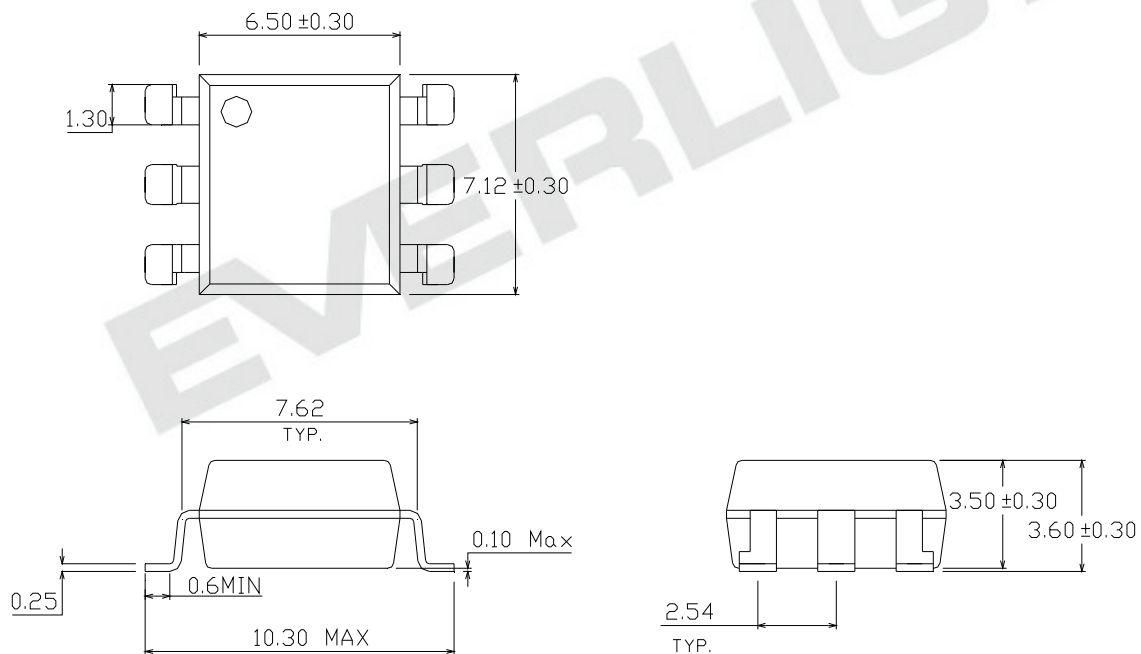
Option M Type



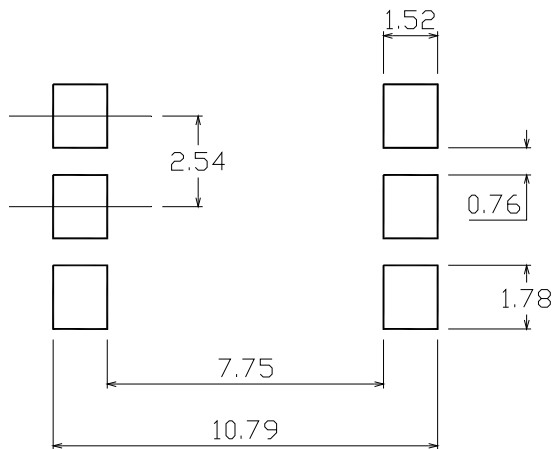
Option S Type



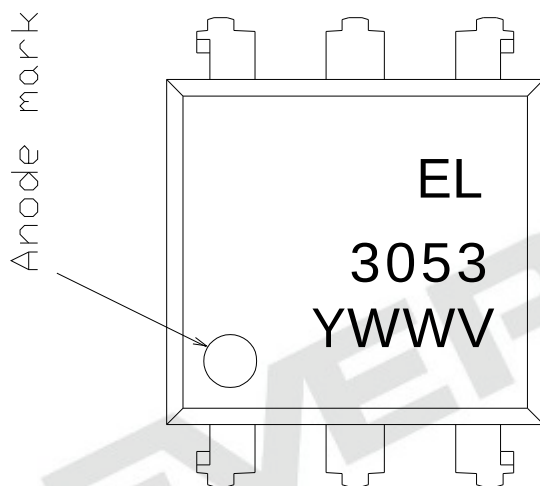
Option S1 Type



Recommended pad layout for surface mount leadform



Device Marking

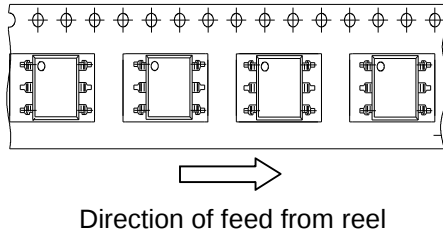


Notes

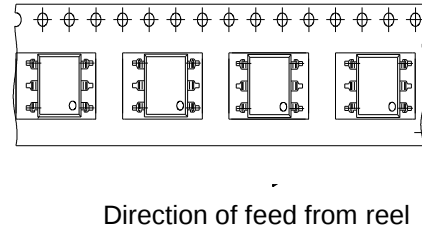
EL	denotes EVERLIGHT
3053	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

Tape & Reel Packing Specifications

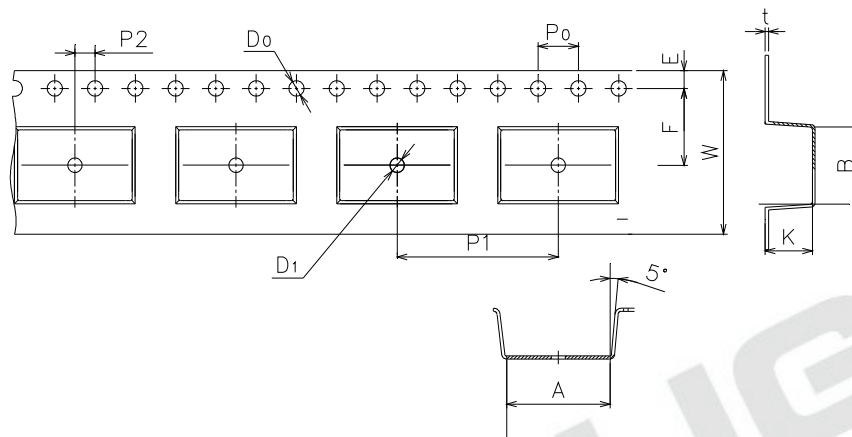
Option TA



Option TB



Tape dimensions



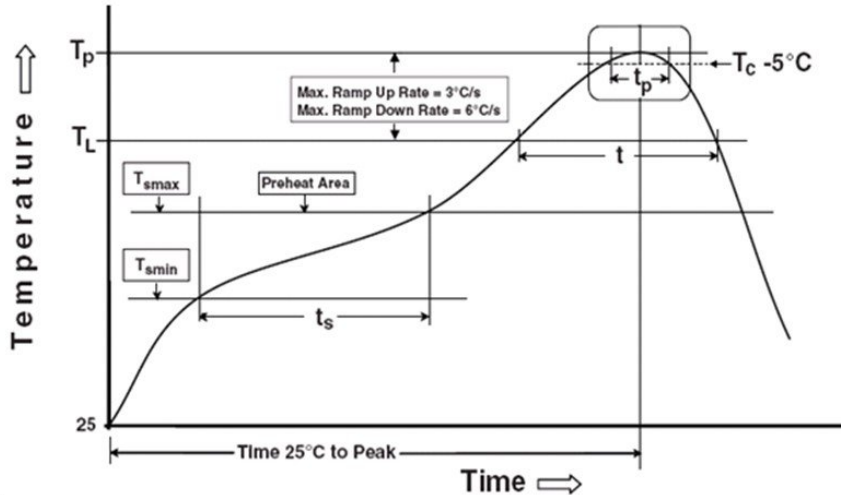
Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min ($T_{\min}$)	150 °C
Temperature max ($T_{\max}$)	200°C
Time ($T_{\min}$ to $T_{\max}$) (t_s)	60-120 seconds
Average ramp-up rate ($T_{\max}$ to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

DISCLAIMER

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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